

Moseni Antenna for LTE applications

Part No. SRFL029

flexiiANT[®]

Product Specification

1. Features

- Antenna for 4G LTE applications including MIMO systems.
- LTE 700, GSM850, GSM900, DCS1800, PCS1900, WCDMA2100, LTE B7 (2500-2690 MHz), LTE B40 (2300 – 2400 MHz)
- 1.13mm diameter RF cable with IPEX MHF connector
- Self-adhesive mounted
- Quick and simple integration minimizes design cycle
- Available in 3 standard cable lengths

2. Description

Moseni is intended for use with 4G LTE applications. This product specification shows the performance of this antenna in all workable bands. Simplified integration with plug and play simplicity.

3. Applications

- Smart meters
- Network devices
- Femto / Pico base stations
- Telematics
- Remote monitoring
- Machine to Machine
- POS (Point of Sale) terminals



4. Part Number

Moseni: SRFL029



5. General Data

Product name	Moseni
Part Number	SRFL029
Frequency	698-798MHz 824-960MHz 1710-2170MHz 2300-2400MHz 2500-2690MHz
Polarization	Linear
Operating temperature	-40°C to +85°C
Impedance with matching	50 Ω
Weight	< 0.5 g
Antenna type	FPC Self-adhesive 3M 468P
Dimensions (Antenna)	110.0 x 20.0 x 0.15 (mm)
Connection	IPEX

6. RF Characteristics

	698 – 798 MHz	824 – 960 MHz	1710 - 2170 MHz
Peak gain	3.50dBi	3.50dBi	3.80dBi
Average gain	-1.60dBi	-1.70dBi	-1.40dBi
Average efficiency	>60%	>60%	>65%
Maximum return loss	-5.0dB	-8.0dB	-5.5dB
Maximum VSWR	3.50:1	2.40:1	3.30:1

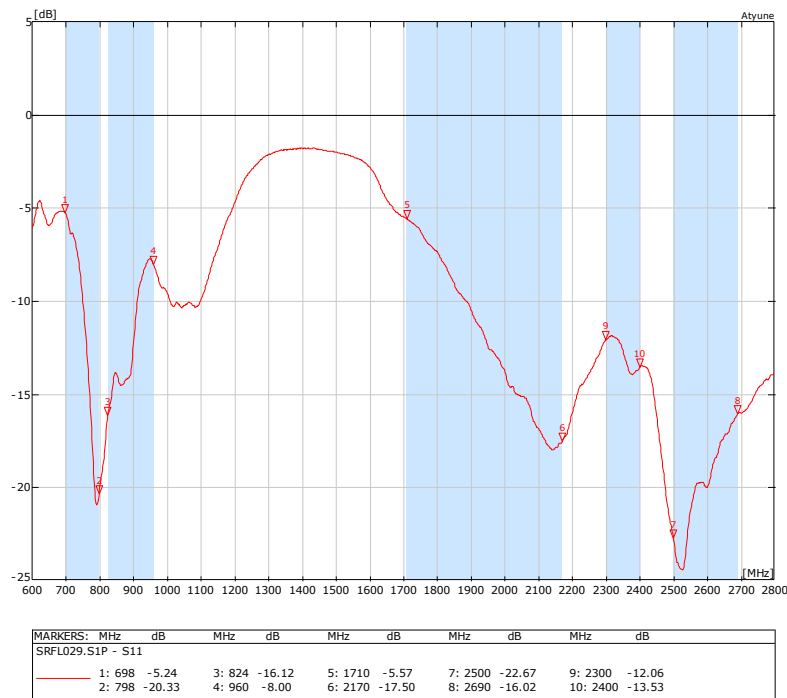
	2300 – 2400 MHz	2500 – 2690 MHz
Peak gain	4.50dBi	4.60dBi
Average gain	-0.70dBi	-0.50dBi
Average efficiency	>80%	>80%
Maximum return loss	-12dB	-16dB
Maximum VSWR	1.40:1	1.70:1

All data measured in a loaded condition adhered to a 1.6mm thick plastic carrier free space.

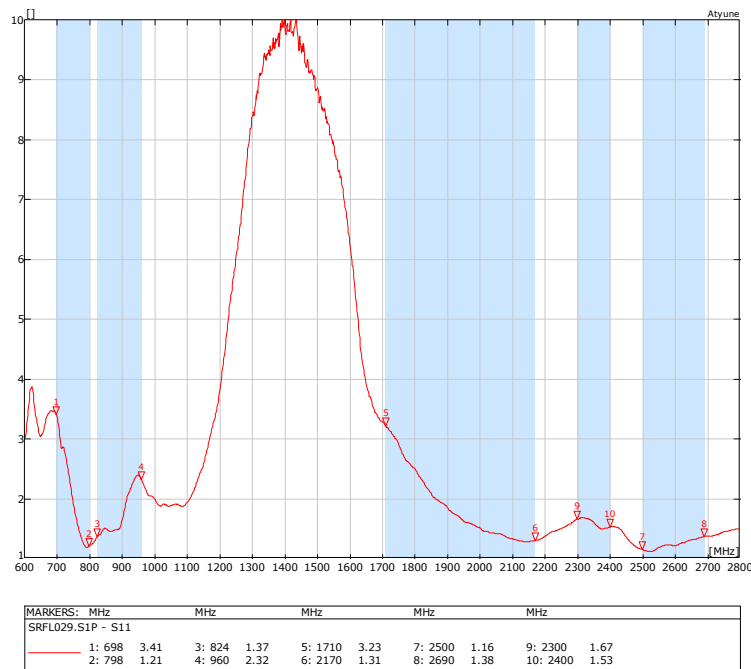
An RF choke was used to prevent cable radiation.

7. RF Performance

7.1 Return Loss

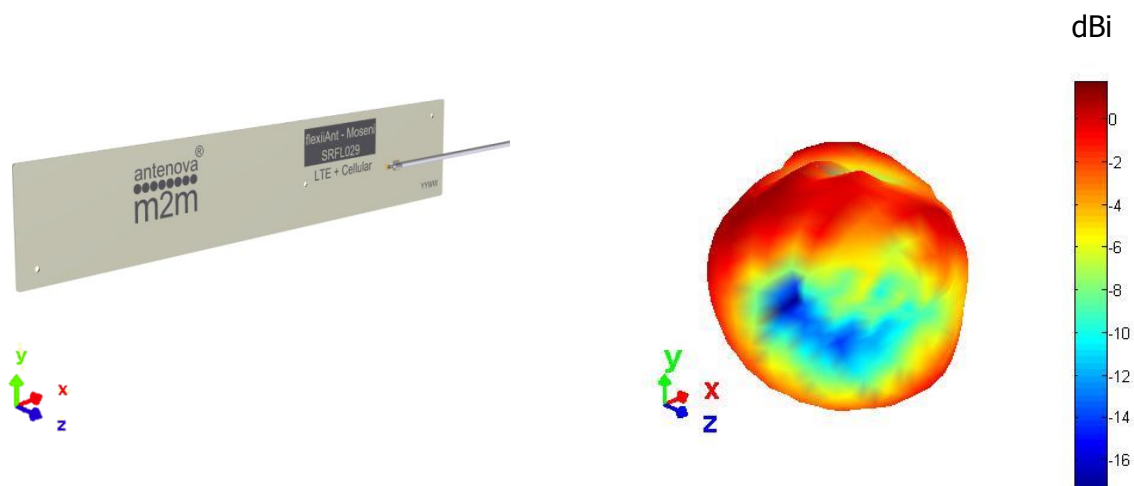


7.2 VSWR



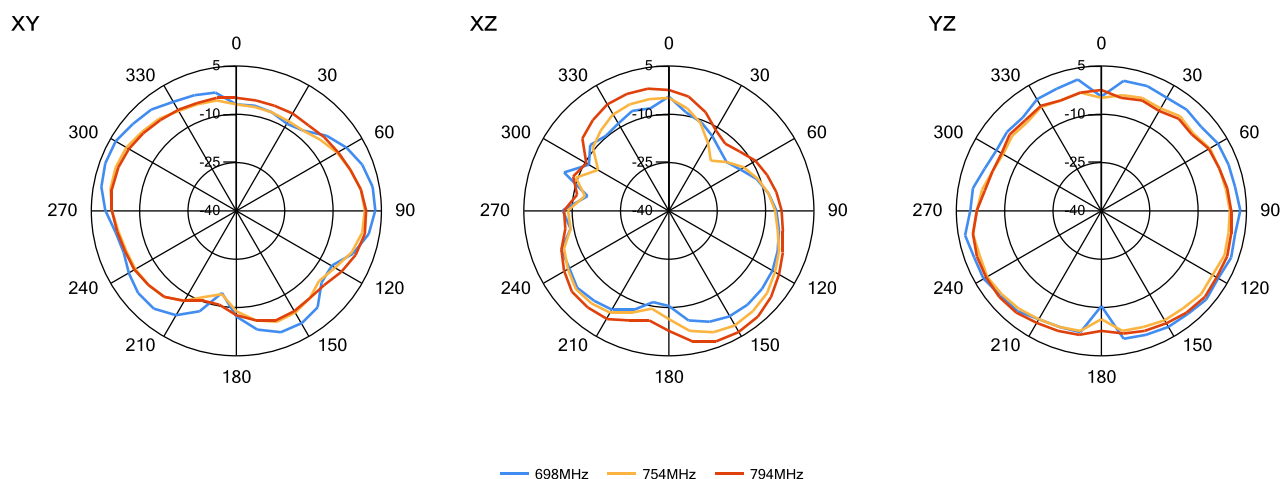
7.3 Antenna patterns

7.3.1 698 MHz – 798 MHz

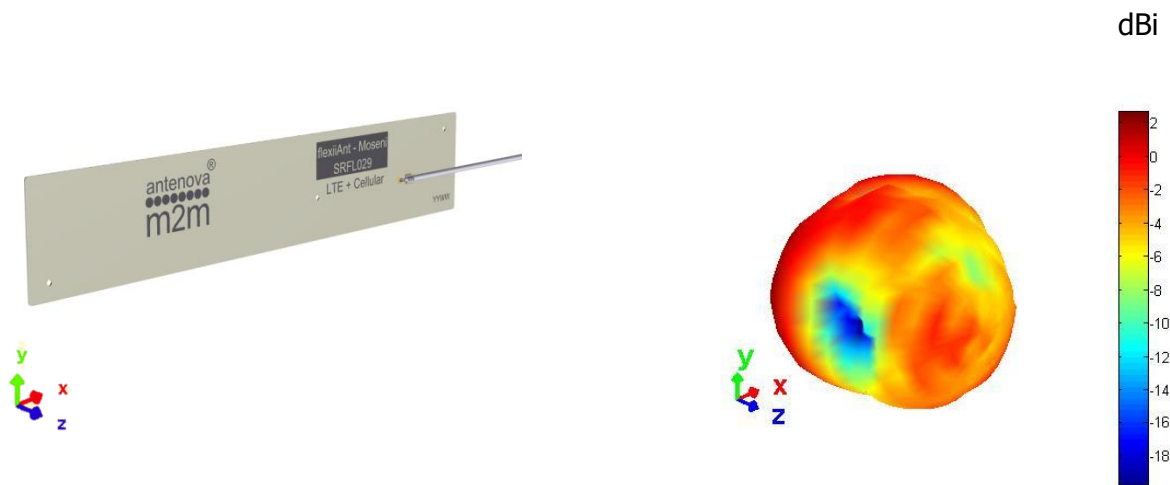


3D pattern at 745 MHz

*Drag to rotate pattern and PCB by using Adobe Reader
(Click to Activate)*

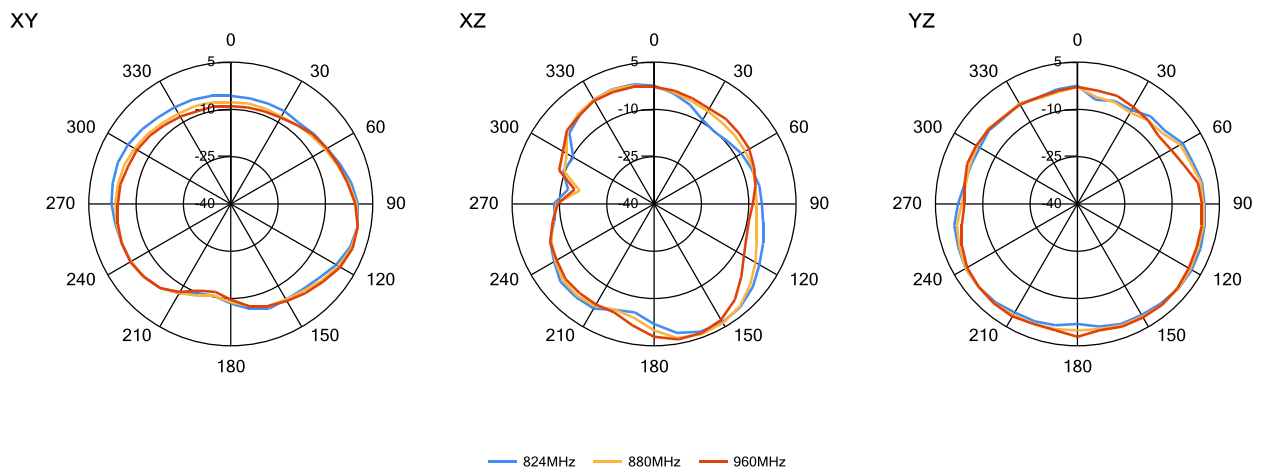


7.3.2 824 MHz – 960 MHz



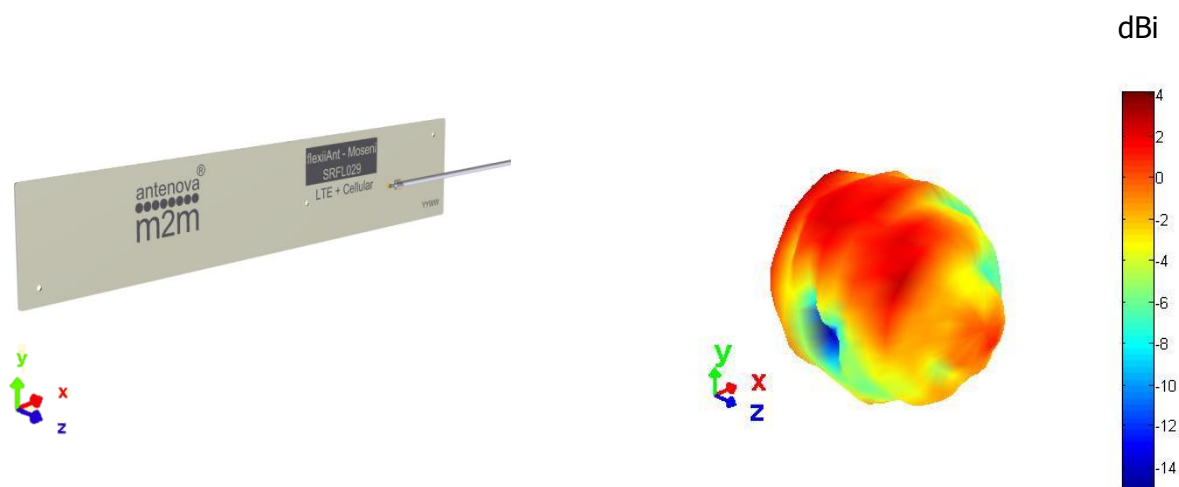
3D pattern at 890 MHz

*Drag to rotate pattern and PCB by using Adobe Reader
(Click to Activate)*



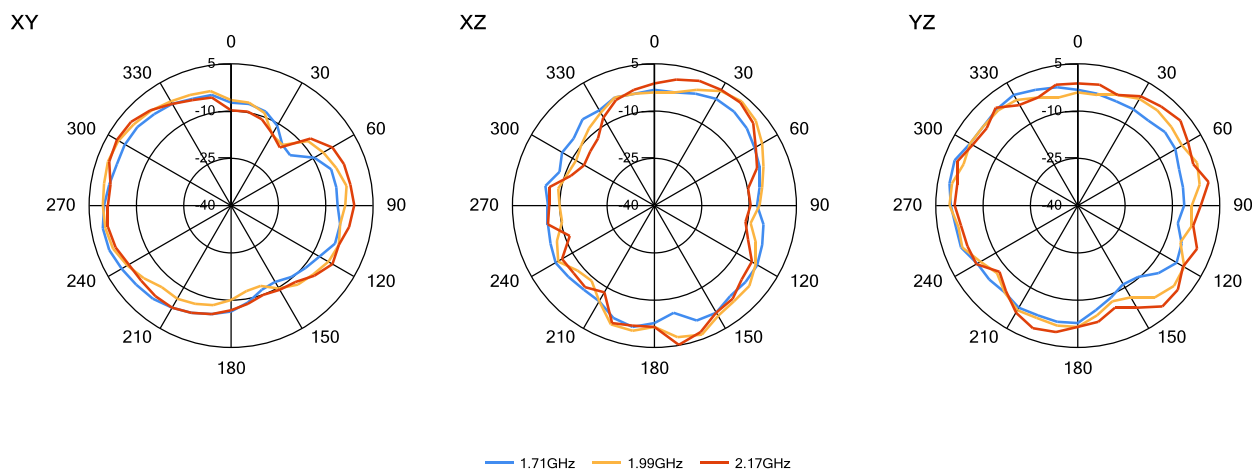
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7.3.3 1710 MHz – 2170 MHz

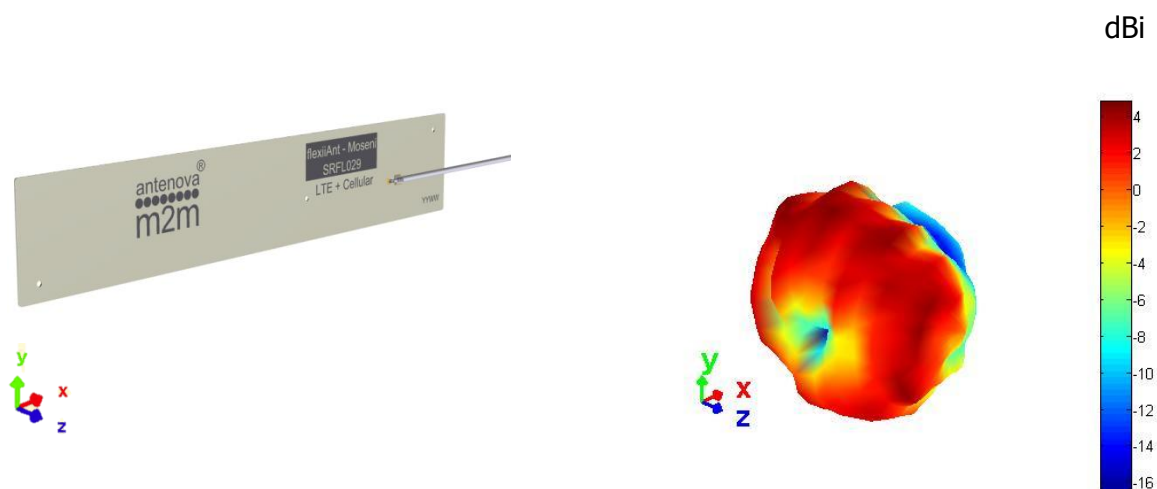


3D pattern at 1990 MHz

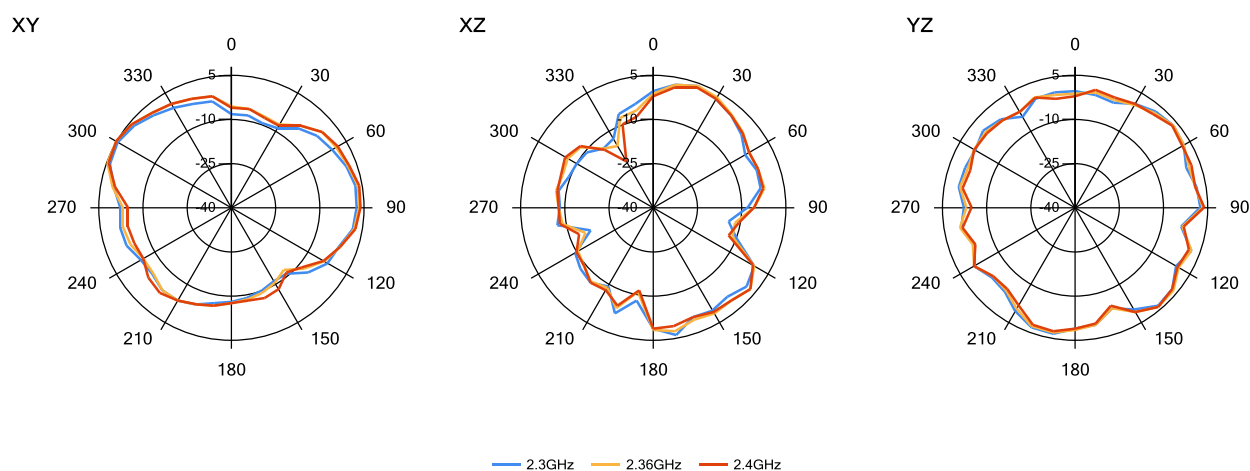
Drag to rotate pattern and PCB by using Adobe Reader
(Click to Activate)



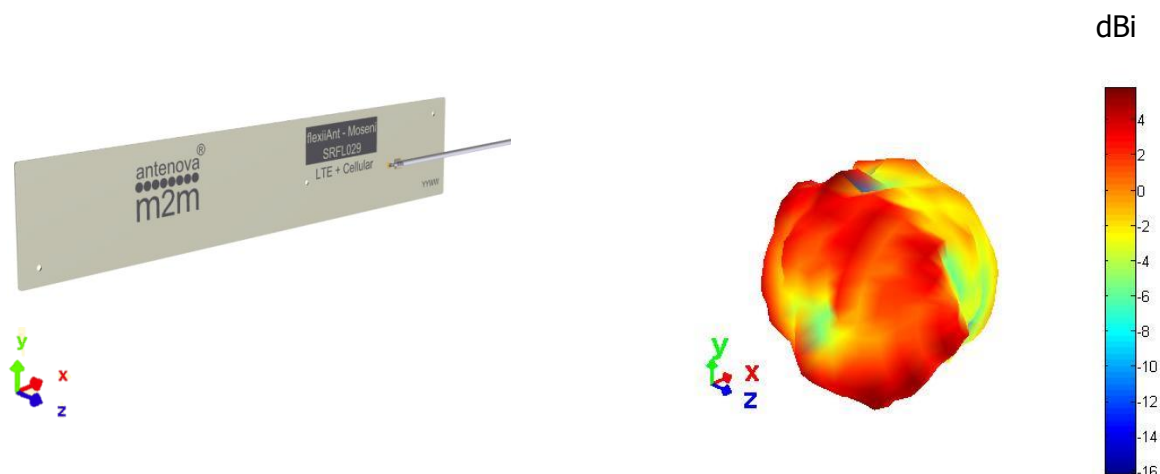
7.3.4 2300 MHz – 2400 MHz



3D pattern at 2350 MHz
Drag to rotate pattern and PCB by using Adobe Reader
(Click to Activate)

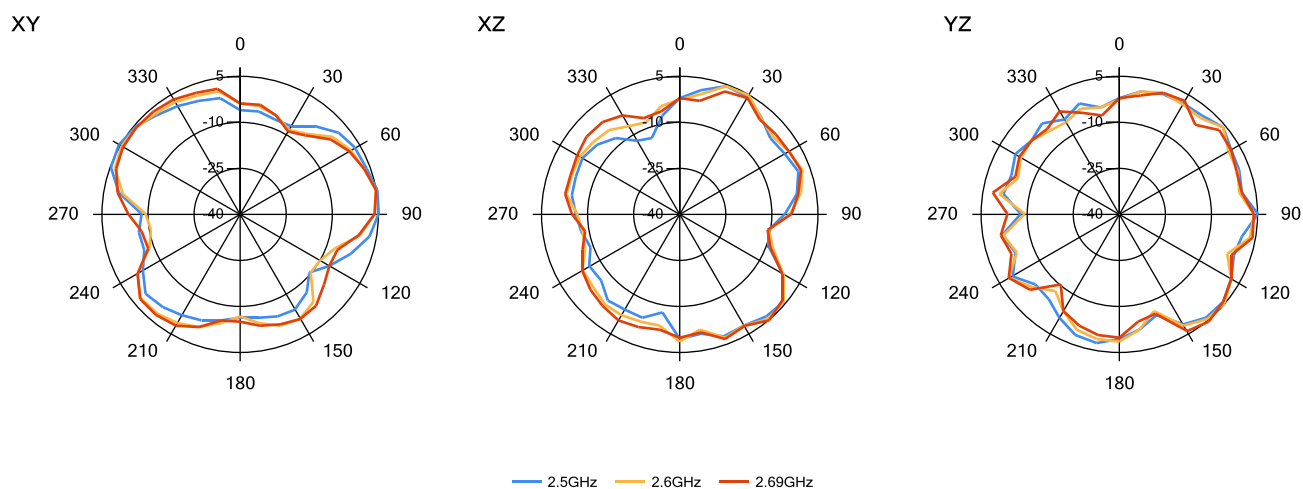


7.3.5 2500 MHz – 2690 MHz



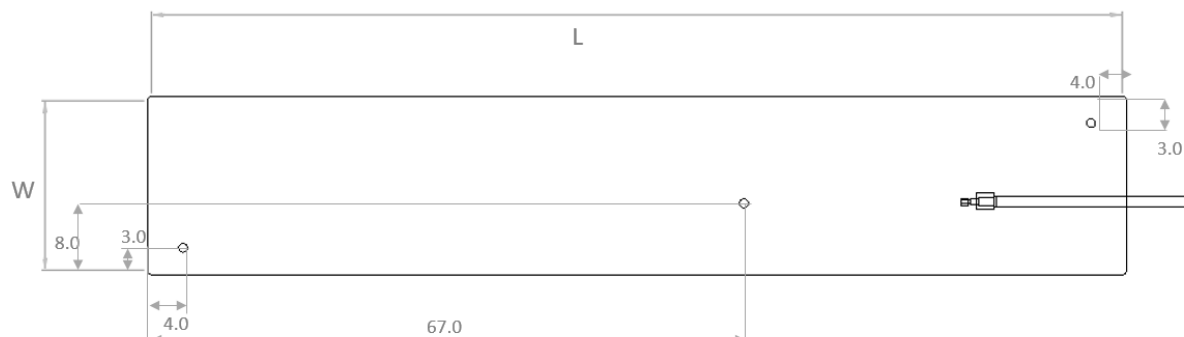
3D pattern at 2600 MHz

Drag to rotate pattern and PCB by using Adobe Reader
(Click to Activate)



8. Antenna Dimensions

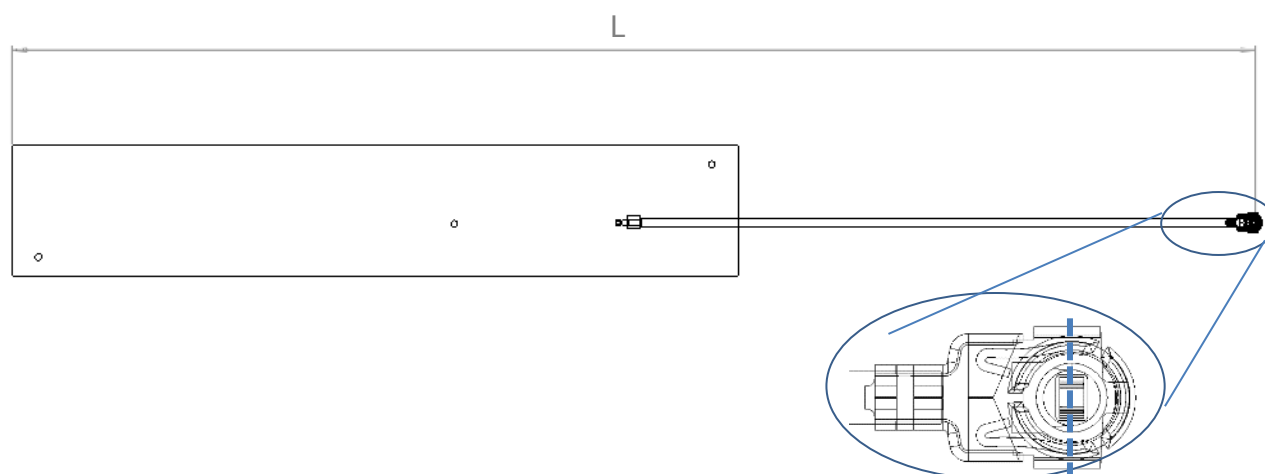
8.1 Dimensions FPC section



L	W	T
Length	Width	Thickness
110.0 ± 0.2 (mm)	20.0 ± 0.2 (mm)	0.15 (mm) nominal

All dimensions in mm

8.2 Dimensions assembled

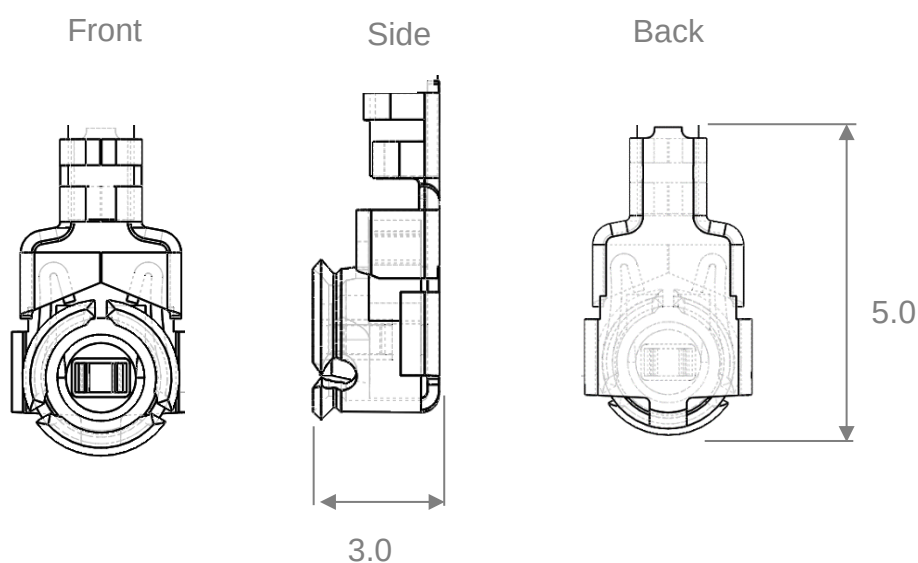
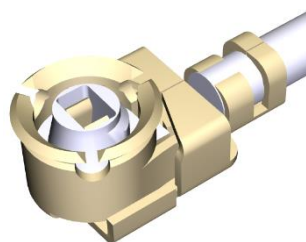


SRFL029-100	SRFL029-150	SRFL029-200
L	L	L
189 ± 2.0 (mm)	239 ± 2.0 (mm)	289 ± 2.0 (mm)

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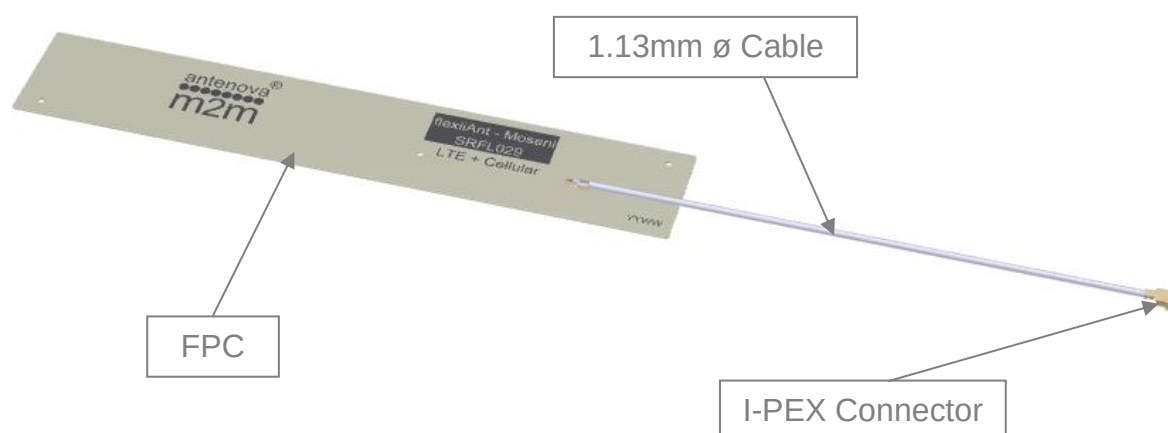
8.3 IPEX Connector

I-PEX	
Material	Copper Alloy
Plating	Ag



All dimensions in mm

8.4 Assembly



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9. Electrical Interface

9.1 Host Interface

The host PCB requires the mating connector which is IPEX MHF (UFL) receptacle. The location should be close to the chip/modules pin for the RF. Any feed from this receptacle should be maintained at 50Ω impedance.

9.2 Transmission Line

All transmission lines should be designed to have a characteristic impedance of 50Ω.

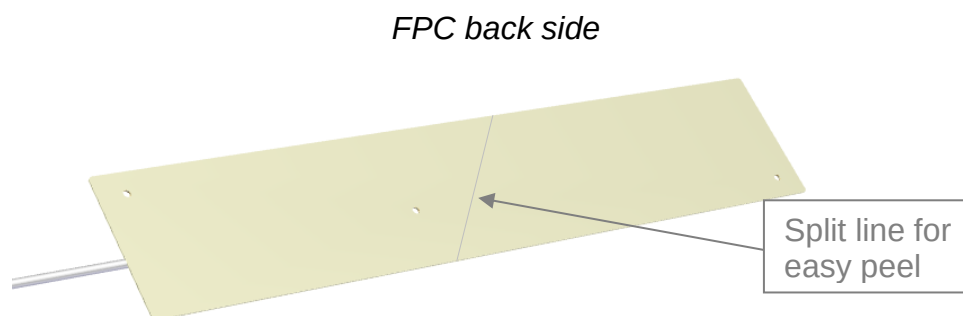
- The length of the transmission lines should be kept to a minimum
- Any other parts of the RF system like transceivers, power amplifiers, etc, should also be designed to have an impedance of 50 Ω

Once the material for the PCB has been chosen (PCB thickness and dielectric constant), a coplanar transmission line can easily be designed using any of the commercial software packages for transmission line design. For the chosen PCB thickness, copper thickness and substrate dielectric constant, the program will calculate the appropriate transmission line width and gaps on either side of the feed.

A DC blocking capacitor should be placed in line to protect the RF front end.

10. Mechanical Fixing

The antenna uses 3M 468MP adhesive on the reverse side of the FPC. The antenna has an easy access split line to peel off to reveal the adhesive side. It is designed for a one time fix to a clean smooth surface.



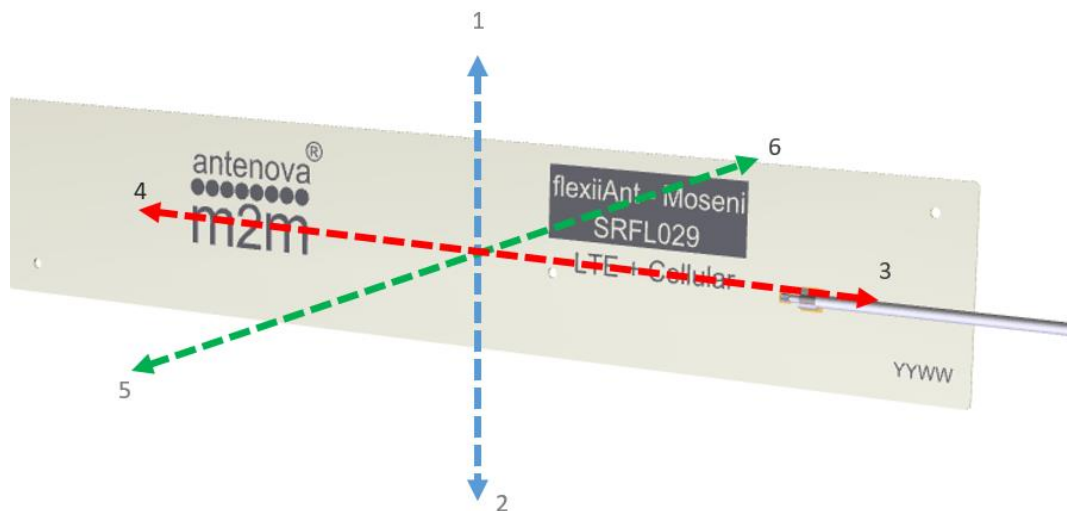
10.0 Antenna Integration Guide

10.1 Placement

For placing the FPC antenna within a device, the host PCB size is not a factor like with PCB mounted antennas. However the placement still needs to follow some basic rules, as any antenna is sensitive to its environment.

Using six spatial directions shown below as a guide. The antenna FPC section should try to maintain a minimum of three directions free from obstructions to be able to operate effectively. The other directions will have obstacles in their paths, these directions still require a minimum clearance. These minimum clearances are further defined in this section. The plastic case is not included in this, only metal objects/components that will obstruct or come in close proximity to the antenna.

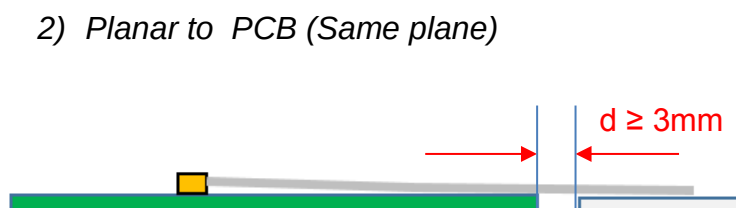
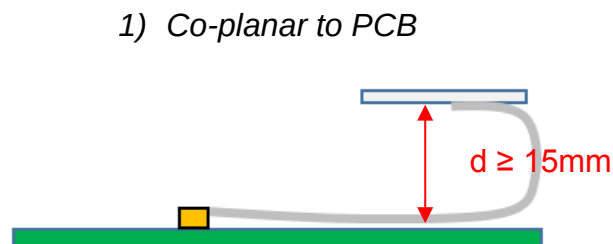
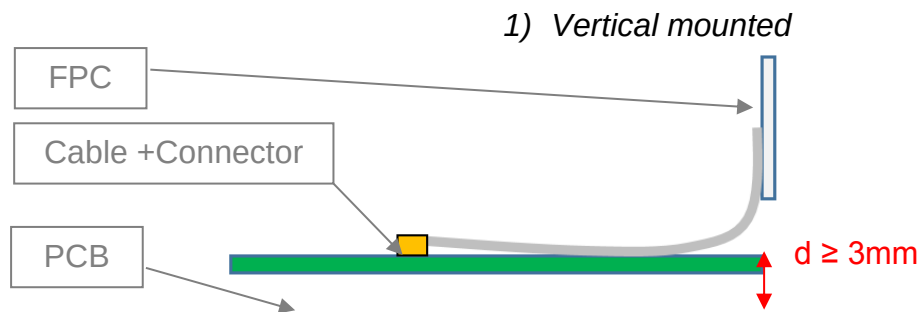
Six spatial directions relative to FPC



10.2 Orientation of FPC

The orientation of the FPC with respect to the host PCB should be defined depending on the unit. The proximity of the GND will have an influence on the antenna so the PCB location relative to the antenna should be considered.

The FPC will normally be placed in one of the three following options for orientation. In each option a distance (d) is the critical dimension to consider. Below shows the minimum value of (d) for each. Other obstructions may increase this dimension.



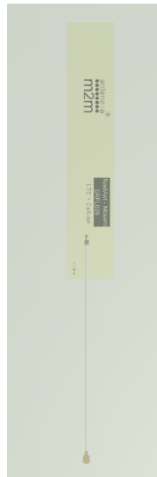
11. Hazardous Material Regulation Conformance

The antenna has been tested to conform to RoHS requirements. A certificate of conformance is available from Antenova M2M's website.

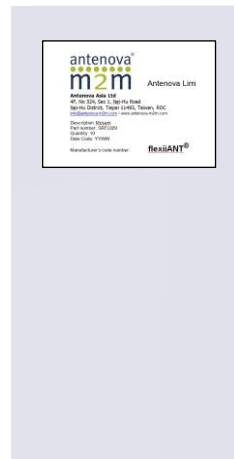
12. Packaging

The antennas are stored in individual plastic (PE) bags. Then stored within a second bag of 10pcs.

Single antenna per bag



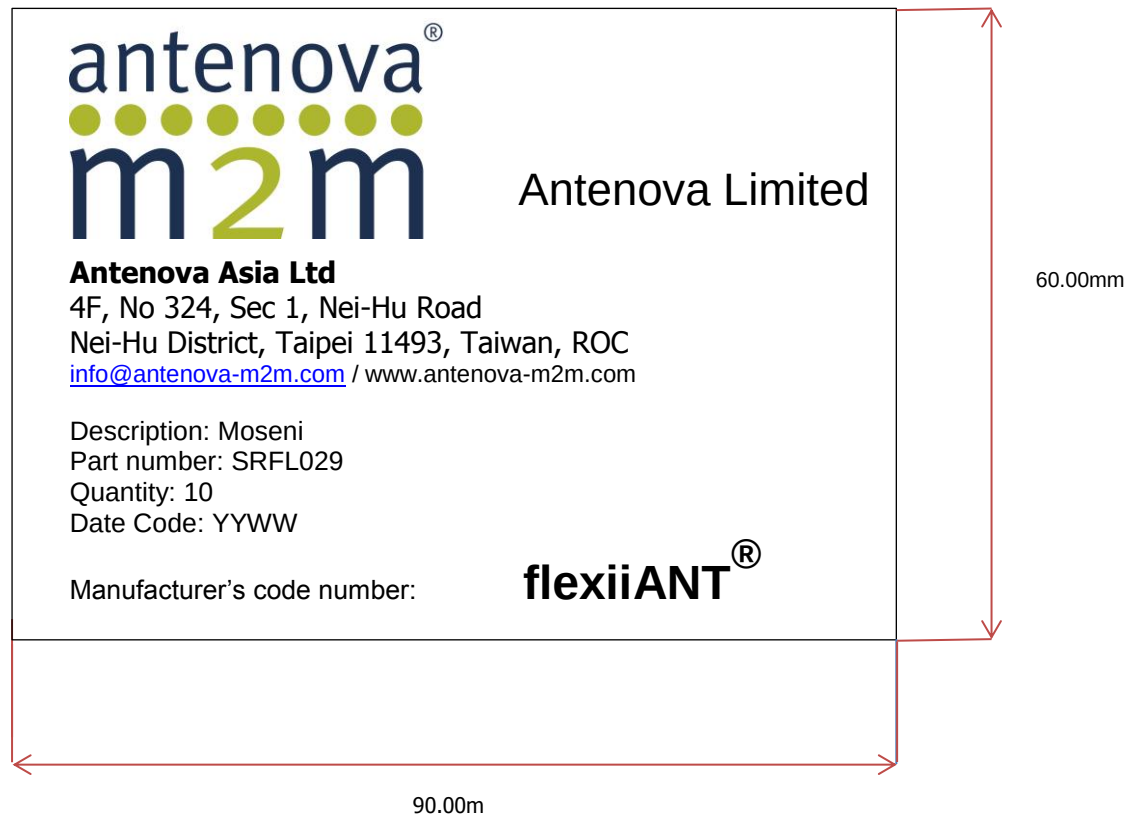
10 units per second bag (Labelled)



12.1 Optimal Storage Conditions

Temperature	-10°C to 40°C
Humidity	Less than 75% RH
Shelf life	18 Months provided the bag of 10 pieces remains factory sealed
Storage place	Away from corrosive gas and direct sunlight
Packaging	Antennas should be stored in unopened sealed manufacturer's plastic packaging.

12.2 Label Information





www.antenova-m2m.com

Corporate Headquarters

Antenova Limited
2nd Floor Titan Court
3 Bishop Square
Hatfield
AL10 9NA
UK

Tel: +44 1223 810600

Email: sales@antenova-m2m.com

North America Headquarters

Antenova Limited
100 Brush Creek Road, Suite 103,
Santa Rosa
California 95404
USA

Tel: +1 707 890 5202

Email: sales@antenova-m2m.com

Asia Headquarters

Antenova Asia Limited
4F, No. 324, Sec. 1, Nei-Hu Road
Nei-Hu District
Taipei 11493
Taiwan, ROC

Tel: +886 (0) 2 8797 8630

Fax: +886 (0) 2 8797 6890

Email: sales@antenova-m2m.com

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Certificate No: 4598

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Для оперативного оформления запроса Вам необходимо перейти по данной ссылке:

<http://moschip.ru/get-element>

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Офис по работе с юридическими лицами:

105318, г.Москва, ул.Щербаковская д.3, офис 1107, 1118, ДЦ «Щербаковский»

Телефон: +7 495 668-12-70 (многоканальный)

Факс: +7 495 668-12-70 (доб.304)

E-mail: info@moschip.ru

Skype отдела продаж:

moschip.ru

moschip.ru_4

moschip.ru_6

moschip.ru_9